

## UML2502

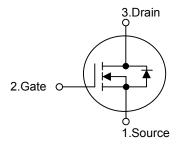
# N-CHANNEL POWER MOSFET

#### DESCRIPTION

The **UML2502** uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

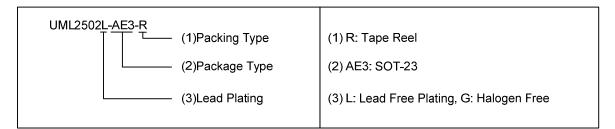
#### FEATURES

- \*  $R_{DS(ON)}$  < 45m $\Omega$ @V<sub>GS</sub> = 4.5V
- \*  $R_{DS(ON)}$  < 80m $\Omega$ @V<sub>GS</sub> = 2.5V
- \* Ultra Low Gate Charge (Max. 12nC)
- \* Low Reverse Transfer Capacitance (  $C_{\mbox{\scriptsize RSS}}$  = Typical 66pF )
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability
- SYMBOL

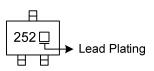


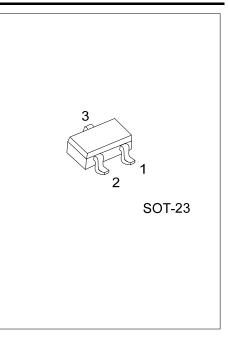
#### ORDERING INFORMATION

Ordering Number		Deekege	Pin Assignment			Deaking	
Lead Free Plating	Halogen Free	Package	1	2	3	Packing	
UML2502L-AE3-R	UML2502G-AE3-R	SOT-23	S	G	D	Tape Reel	



#### MARKING





### **Power MOSFET**

#### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> =25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT	
Drain-Source Voltage	V <sub>DSS</sub>	20	V	
Gate-Source Voltage	V <sub>GSS</sub>	±12	V	
Continuous Drain Current V <sub>GS</sub> =4.5V	ID	4.2	А	
Pulsed Drain Current (Note 2)	I <sub>DM</sub>	33	А	
Maximum Power Dissipation	D	1.25	W	
Linear Derating Factor	PD	0.01	W/℃	
Junction Temperature	TJ	+150	°C	
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C	

 Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Pulse width limited by T<sub>J(MAX)</sub>

#### THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ <sub>JA</sub>	75 ~ 100	°C/W

#### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub> =25 °C, unless otherwise specified)

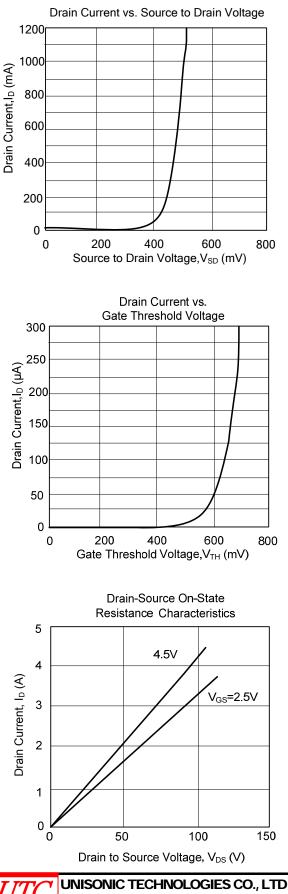
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS	•			1		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250µA	20			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =16V			1.0	μA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V			±100	nA
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_{J}$	Reference to 25°C, I <sub>D</sub> =1mA		0.01		V/℃
ON CHARACTERISTICS						_
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	0.6		1.2	V
Drain Source On State Desistance (Note)	D	V <sub>GS</sub> =4.5V, I <sub>D</sub> =4.2A		35	45	mΩ
Drain-Source On-State Resistance (Note)	R <sub>DS(ON)</sub>	V <sub>GS</sub> =2.5V, I <sub>D</sub> =3.6A		50	80	
DYNAMIC CHARACTERISTICS						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V. V <sub>DS</sub> =15V.		740		рF
Output Capacitance	Coss	f=1.0MHz		90		рF
Reverse Transfer Capacitance	C <sub>RSS</sub>	1-1.00012		66		рF
SWITCHING PARAMETERS						
Turn-ON Delay Time (Note)	t <sub>D(ON)</sub>			7.5		ns
Turn-ON Rise Time	t <sub>R</sub>	$V_{DS}$ =10V, $R_{G}$ =6 $\Omega$ , $R_{D}$ =10 $\Omega$ ,		10		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>	I <sub>D</sub> =1.0A		54		ns
Turn-OFF Fall-Time	t⊨			26		ns
Total Gate Charge (Note)	$Q_G$	V <sub>GS</sub> =5.0V, V <sub>DS</sub> =10V,		8.0	12	nC
Gate Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> =5.0V, V <sub>DS</sub> =10V, I⊳=4.0A		1.8	2.7	nC
Gate Drain Charge	$Q_{GD}$	1D-4.0A		1.7	2.6	nC
SOURCE- DRAIN DIODE RATINGS AND C	HARACTERIS	TICS	-			-
Diode Forward Voltage	$V_{SD}$	V <sub>GS</sub> =0V, I <sub>S</sub> =1.3A, T <sub>J</sub> =25℃ (Note)			1.2	V
Maximum Pulsed Drain-Source Diode	lau				33	А
Forward Current	I <sub>SM</sub>				55	~
Maximum Continuous Drain-Source Diode	I <sub>S</sub>				1.3	А
Forward Current	13					
Reverse Recovery Time	t <sub>RR</sub>	I <sub>F</sub> =1.3A, dl/dt=100A/μs,		16	24	ns
Reverse Recovery Charge	Q <sub>RR</sub>	T <sub>J</sub> =25℃ (Note)		8.6	13	nC

Notes: Pulse width  $\leq$  300µs; duty cycle  $\leq$  2%.

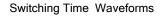


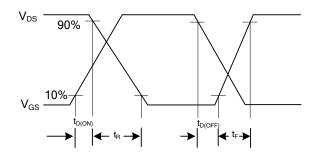
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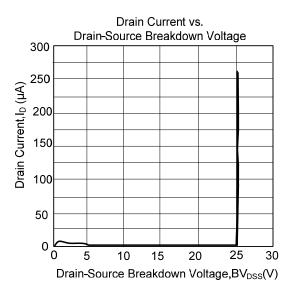
#### TYPICAL CHARACTERISTICS



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